Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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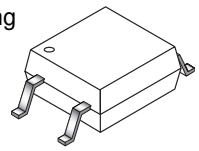
FAIRCHILD
SEMICONDUCTOR®

FULL PITCH MINI-FLAT PACKAGE 4-PIN OPTOCOUPLERS

HMA121 Series HMA124 HMA2701 Series HMAA2705

DESCRIPTION

The HMA124, HMA121 series and HMA2701 series consists of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a compact 4-pin mini-flat package. The lead pitch is 2.54 mm.



The HMAA2705 consists of two gallium arsenide infrared emitting diodes, connected in inverse parallel, driving a single silicon phototransistor in a compact 4-pin mini-flat package. The lead pitch is 2.54mm.

FEATURES

- Compact 4-pin package
  (2.4 mm maximum standoff height)
- Current Transfer Ratio in selected groups

HMA121: 50–600%	HMA2701: 50–300%
HMA121A: 100–300%	HMA2701A: 150–300%
HMA121B: 50–150%	HMA2701B: 80–160%
HMA121C: 100–200%	HMA124: 100% MIN
HMA121D: 50–100%	HMAA2705: 50–300%
HMA121E: 150–300%	
HMA121F: 100–600%	

- Available in tape and reel quantities of 500 and 2500.
- Applicable to Infrared Ray reflow (230°C max, 30 seconds.)
- BSI (File #8611/8612), CSA (File #1162301), UL (File #E90700) and VDE (File #136480) certified
- Creepage ≥ 5 mm, typical 5.2 mm
- Clearance ≥ 5 mm, typical 5.2 mm

APPLICATIONS

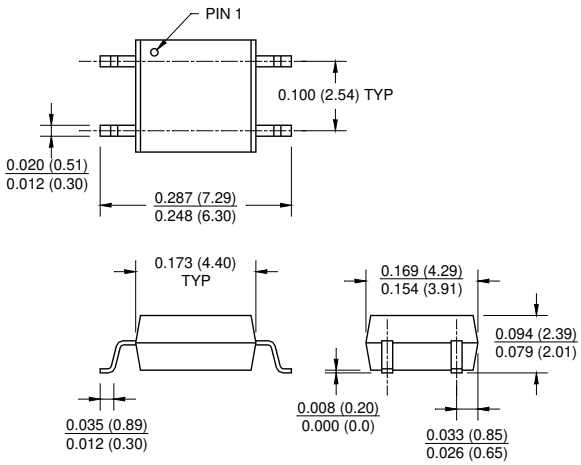
HMAA2705

- AC line monitor
- Unknown polarity DC sensor
- Telephone line receiver

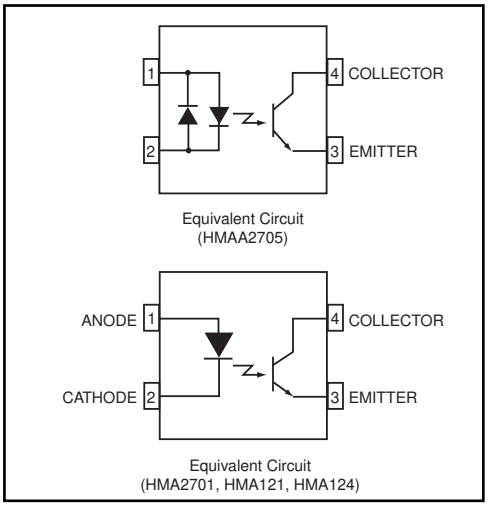
HMA121 series, HMA2701 series, HMA124

- Digital logic inputs
- Microprocessor inputs
- Power supply monitor
- Twisted pair line receiver
- Telephone line receiver

PACKAGE DIMENSIONS



NOTE
All dimensions are in inches (millimeters)



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise specified)				
Parameter		**Symbol**	**Value**	**Units**
TOTAL PACKAGE				
Storage Temperature		T_{STG}	-40 to +125	°C
Operating Temperature		T_{OPR}	-40 to +100	°C
EMITTER				
Continuous Forward Current		$I_{F\ (avg)}$	50	mA
Peak Forward Current (1 µs pulse, 300 pps.)		$I_{F\ (pk)}$	1	A
Reverse Input Voltage (HMA)		V_R	6	V
Power Dissipation		P_D	70	mW
Derate linearly (above 25°C)			0.65	mW/°C
DETECTOR				
Continuous Collector Current			80	mA
Power Dissipation		P_D	150	mW
Derate linearly (above 25°C)			2.0	mW/°C
Collector-Emitter Voltage	HMA2701 Series, HMAA2705	V_{CEO}	40	V
	HMA121 Series, HMA124		80	
Emitter-Collector Voltage		V_{ECO}	7	V

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

INDIVIDUAL COMPONENT CHARACTERISTICS

Parameter	Test Conditions	Symbol	Device	Min	Typ**	Max	Unit
EMITTER Forward Voltage	(I_F = 10 mA)	V_F	HMA121 Series	1.0		1.3	V
			HMA124				
	(I_F = 5 mA)		HMA2701 Series			1.4	
	(I_F = ± 5 mA)		HMAA2705				
Reverse Current	(V_R = 5 V)	I_R	HMA2701 Series			5	µA
			HMA121 Series				
			HMA124				
DETECTOR Breakdown Voltage Collector to Emitter	(I_C = 1 mA, I_F = 0)	BV_{CEO}	HMA121 Series	80			V
			HMA124				
			HMA2701 Series	40			
			HMAA2705				
Emitter to Collector	(I_E = 100 µA, I_F = 0)	BV_{ECO}	All	7			
Collector Dark Current	(V_{CE} = 40 V, I_F = 0)	I_{CEO}	All			100	nA
Capacitance	(V_{CE} = 0 V, f = 1 MHz)	C_{CE}	All		10		pF

TRANSFER CHARACTERISTICS (T_A = 25°C)

Characteristic	Test Conditions	Symbol	Device	Min	Typ**	Max	Unit
DC Current Transfer Ratio	(I_F = ± 5 mA, V_{CE} = 5 V)	CTR	HMAA2705	50		300	%
	(I_F = 5 mA, V_{CE} = 5 V)		HMA2701	50		300	
			HMA2701A	150		300	
			HMA2701B	80		160	
	(I_F = 5 mA, V_{CE} = 5 V)		HMA121	50		600	
			HMA121A	100		300	
			HMA121B	50		150	
			HMA121C	100		200	
			HMA121D	50		100	
			HMA121E	150		300	
			HMA121F	100		600	
	(I_F = 1 mA, V_{CE} = 0.4 V)		HMA121F	30			
	(I_F = 1 mA, V_{CE} = 0.5 V)		HMA124	100		1200	
	(I_F = 0.5 mA, V_{CE} = 1.5 V)		HMA124	50		—	
CTR Symmetry	(I_F = ± 5 mA, V_{CE} = 5 V)	—	HMAA2705	0.3		3.0	
Saturation Voltage	(I_F = ± 10 mA, I_C = 2 mA)	$V_{CE\ (SAT)}$	HMAA2705			0.3	V
	(I_F = 10 mA, I_C = 2 mA)		HMA2701			0.3	
			HMA2701A			0.3	
			HMA2701B			0.3	
	(I_F = 8 mA, I_C = 2.4 mA)		HMA121			0.4	
			HMA121A			0.4	
			HMA121B			0.4	
			HMA121C			0.4	
			HMA121D			0.4	
			HMA121E			0.4	
			HMA121F			0.4	
	(I_F = 1 mA, I_C = 0.2 mA)		HMA121F			0.4	
	(I_F = 1 mA, I_C = 0.5 mA)		HMA124			0.4	
Rise Time (Non-Saturated)	(I_C = 2 mA, V_{CE} = 5 V) (R_L = 100Ω)	t_r			3		µs
Fall Time (Non-Saturated)	(I_C = 2 mA, V_{CE} = 5 V) (R_L = 100Ω)	t_f			3		µs

ISOLATION CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Device	Min	Typ**	Max	Unit
Steady State Isolation Voltage	(1 Minute)	V_{ISO}	All	3750			VRMS

** All typicals at TA = 25°C

TYPICAL PERFORMANCE CURVES

Fig. 1 Forward Current vs. Forward Voltage

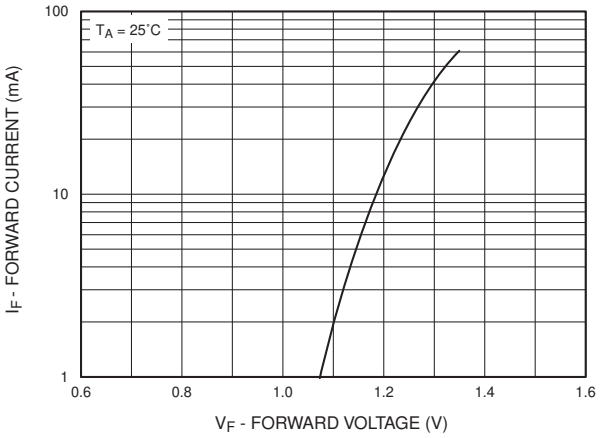


Fig. 2 Collector Current vs. Forward Current

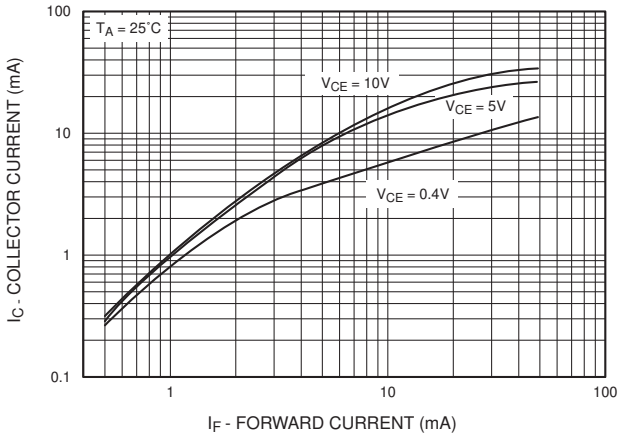


Fig. 3 Current Transfer Ratio vs. Forward Current

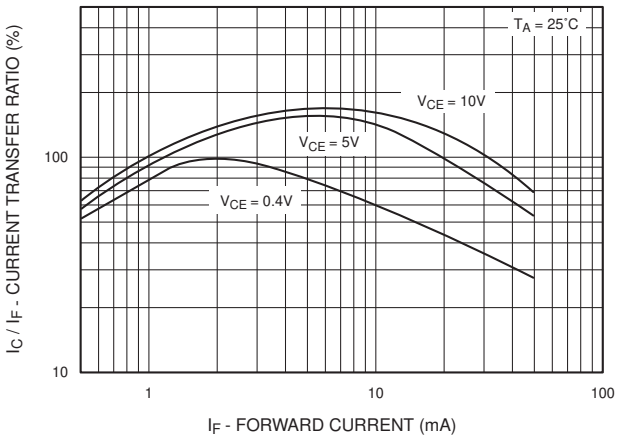


Fig. 4 Collector Current vs. Temperature

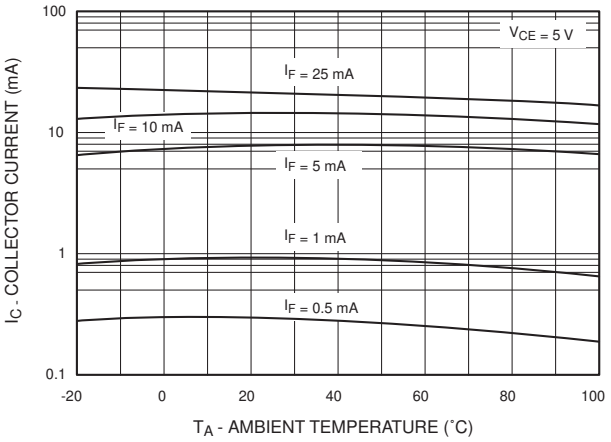


Fig. 5 Collector Current vs. Collector-Emitter Voltage

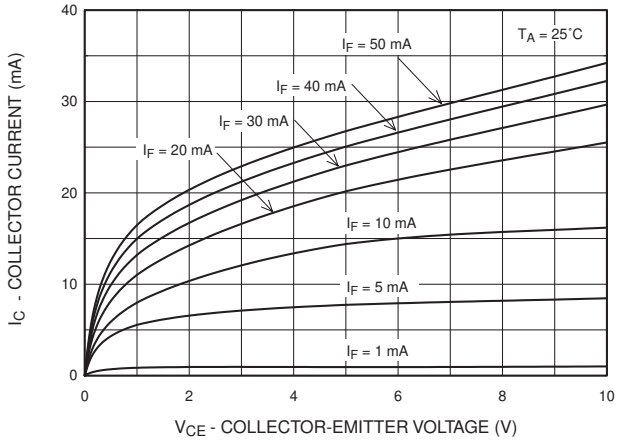


Fig. 6 Collector Current vs. Collector-Emitter Voltage

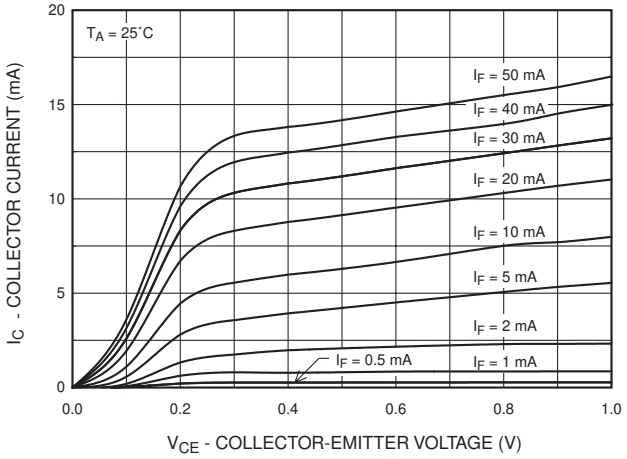


Fig. 7 Collector Dark Current vs. Temperature

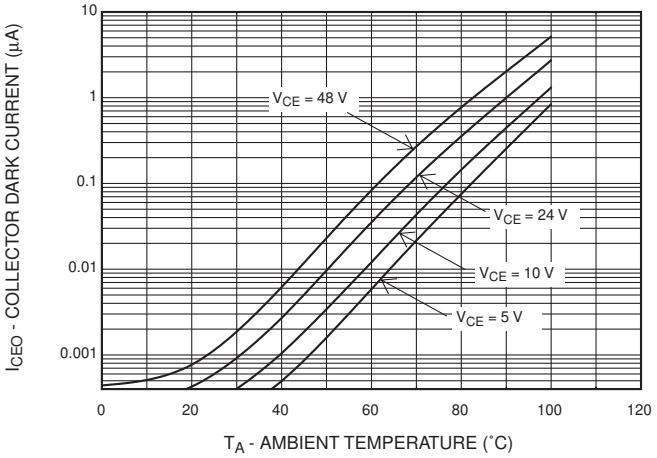


Fig. 8 Switching Time vs. Load Resistance

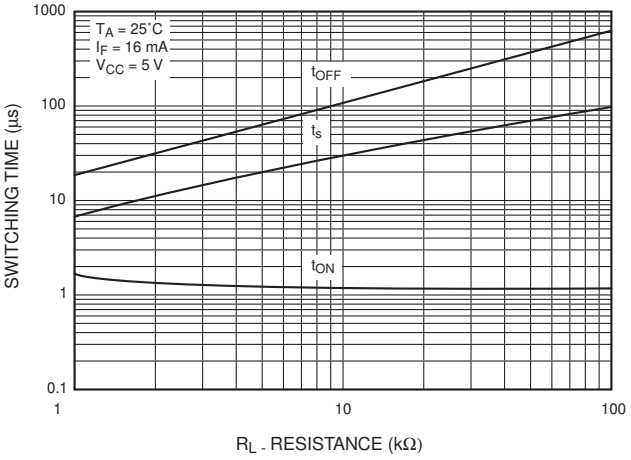
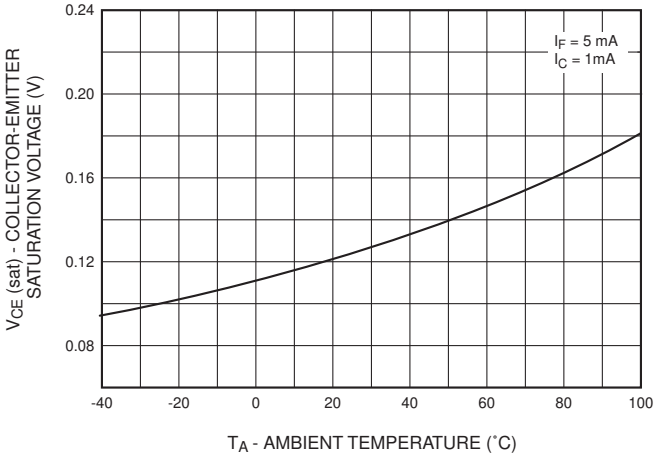


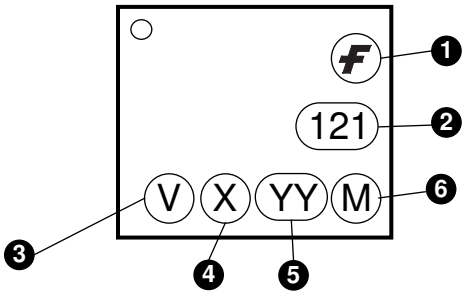
Fig. 9 Collector-Emitter Saturation Voltage vs. Temperature



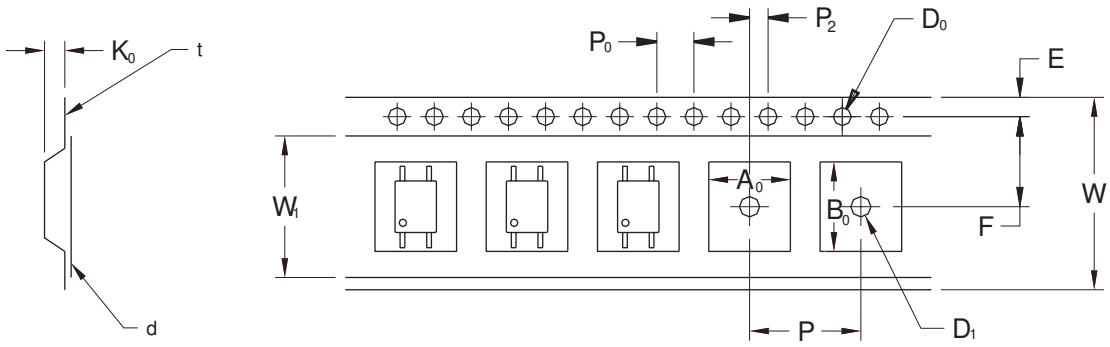
ORDERING INFORMATION

Option	Description
V	VDE Approved
R1	Tape and Reel (500 units)
R2	Tape and Reel (2500 units)
R3	Tape and Reel (500 units; unit 180° rotated)
R4	Tape and Reel (2500 units; unit 180° rotated)
R1V	Tape and Reel (500 units) and VDE Approved
R2V	Tape and Reel (2500 units) and VDE Approved
R3V	Tape and Reel (500 units; unit 180° rotated) and VDE Approved
R4V	Tape and Reel (2500 units; unit 180° rotated) and VDE Approved

MARKING INFORMATION

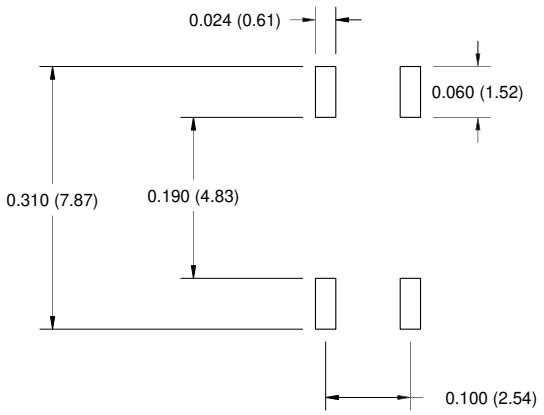


Definitions	
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code
5	Two digit work week ranging from ‘01’ to ‘53’
6	Assembly package code

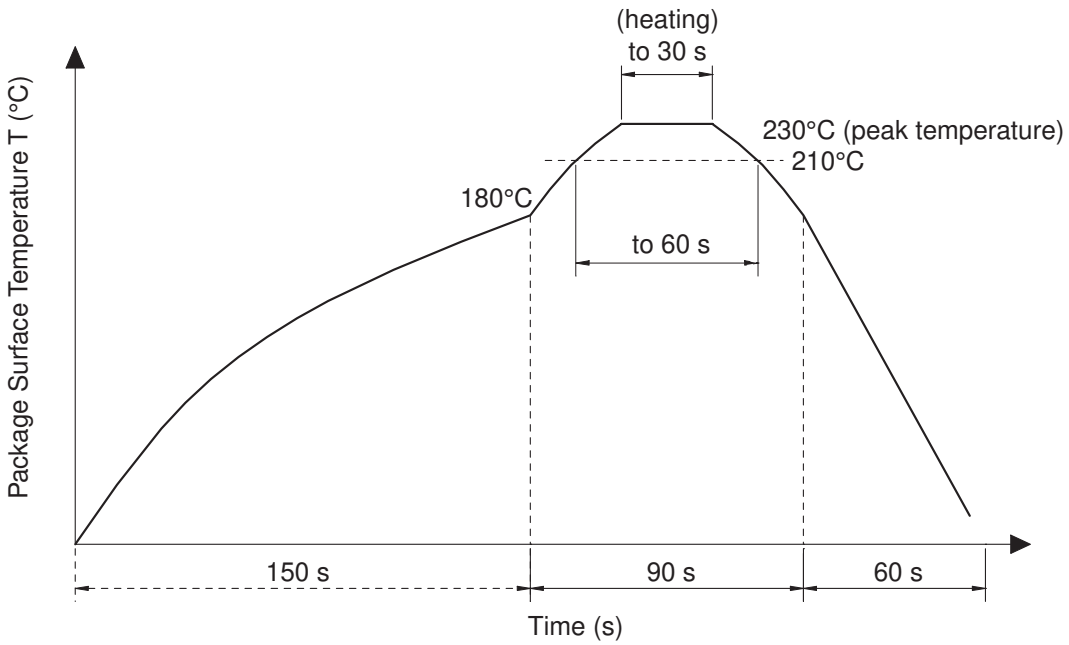


Description		Symbol	2.54 Pitch Dimensions (mm)
Tape Width		W	12.00±0.4
Tape Thickness		t	0.30±0.20
Sprocket Hole Pitch		P_0	4.00±0.20
Sprocket Hole Dia.		D_0	1.55±0.20
Sprocket Hole Location		E	1.75±0.20
Pocket Location		F	5.50±0.20
		P_2	2.00±0.20
Pocket Pitch		P	8.00±0.20
Pocket Dimension		A_0	4.40±0.20
		B_0	7.30±0.20
		K_0	2.30±0.20
Pocket Hole Dia.		D_1	1.55±0.20
Cover Tape Width		W_1	9.20
Cover Tape Thickness		d	0.065±0.02
Max. Component Rotation or Tilt			20˚ max
Devices Per Reel	R1		500
	R2		2500
Reel Diameter	R1		178 mm (7")
	R2		330 mm (13")

Footprint Drawing for PCB Layout



Recommended Infrared Reflow Soldering Profile



- Peak reflow temperature: 230°C (package surface temperature) for 30 seconds
- Time of temperature higher than 210°C: 60 seconds or less
- One time soldering reflow is recommended

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.